



(1.00 mm) .0394"

MEC1-RA, MEC1-EM SERIES

RA₁

RIGHT-ANGLE/EDGE MOUNT SOCKETS

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?MEC1-RA

Insulator Material:

Black LCP
Contact Material:
Phosphor Bronze
Plating: Au or Sn over
50 μ" (1.27 μm) Ni
Current Rating: 1.6 A per pin
(2 adjacent pins powered)
Operating Temp Range:
-55 °C to +125 °C
Insertion Depth:
(5.84 mm) .230" to (8.13 mm) .320"
RoHS Compliant: Yes

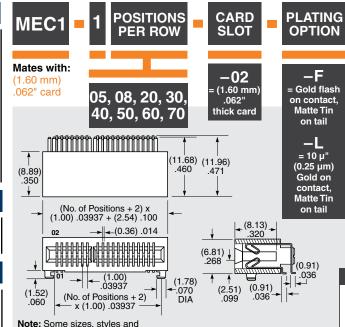
PROCESSING

Lead-Free Solderable: Yes **SMT Lead Coplanarity:** (0.10 mm) .004" max (05-40) (0.15 mm) .006" max (50-70)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality





POSITIONS POLARIZED **PER ROW POSITIONS** 05 3, 4 08 5.6 20 15, 16 30 21.22 40 31, 32 50 41 42 60 31, 32, 63 & 64 53, 54, 115 & 116 70

D

Note: While optimized for 50 Ω applications, this connector with alternative signal/ground patterns may also perform well in certain 75 Ω applications. Contact Samtec for further information.

-NP
= No Polarization
(8 positions only)
Leave Blank for
polarization

ALSO AVAILABLE (MOQ Required)

- Elevated body height
- Other platings
 Contact Samtec.

HIGH-SPEED CHANNEL PERFORMANCE

MEC1-RA

Rating based on Samtec reference channel. For full SI performance data visit Samtec.com or contact SIG@samtec.com **14**G b p s

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?MEC1-EM

Insulator Material:

Black LCP Contact Material: Phosphor Bronze

Plating: Au or Sn over 50 µ" (1.27 µm) Ni Current Rating:

1.8 A per pin (2 adjacent pins powered) Operating

Temp Range: -55 °C to +125 °C Insertion Depth: (5.84 mm) .230" to (8.13 mm) .320" RoHS Compliant:

Lead-Free Solderable: Yes

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality

FILE NO. E111594

Mates with: (1.60 mm) .062" card 05, 08, 20, 30, 40, 50, 60, 70 AVAILABLE (MOQ Required) Edge mount leads for (0.80 mm) .031" (No. of Positions + 2) x (1.00) .03937 + (12.45) .490

options are non-standard,

non-returnable

MEC₁

thick board

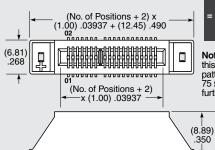
Contact Samtec.

Other platings

Note: Some sizes,

styles and options

are non-standard,



POSITIONS

PER ROW

APPLICATION

Samtec recommends that pads on the mating board be Gold plated.

02

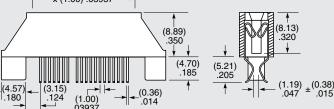
– F = Gold flash on contact, Matte Tin on tail

PLATING

OPTION

= 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail

Note: While optimized for 50 Ω applications, this connector with alternative signal/ground patterns may also perform well in certain 75 Ω applications. Contact Samtec for further information.



-NP
= No Polarization
(8 positions only)
Leave Blank for
polarization

EM2

PER ROW	POLARIZED
05	3, 4
08	5, 6
20	15, 16
30	21, 22
40	31, 32
50	41, 42
60	31, 32, 63 & 64
70	53, 54, 115 & 116

Due to technical progress, all designs, specifications and components are subject to change without notice